

September 1983 Revised February 1999

MM74HC139 Dual 2-To-4 Line Decoder

General Description

The MM74HC139 decoder utilizes advanced silicon-gate CMOS technology, and is well suited to memory address decoding or data routing applications. It possesses the high noise immunity and low power consumption usually associated with CMOS circuitry, yet has speeds comparable to low power Schottky TTL logic.

The MM74HC139 contain two independent one-of-four decoders each with a single active low enable input (G1, or G2). Data on the select inputs (A1, and B1 or A2, and B2) cause one of the four normally high outputs to go LOW.

The decoder's outputs can drive 10 low power Schottky TTL equivalent loads, and are functionally as well as pin

equivalent to the 74LS139. All inputs are protected from damage due to static discharge by diodes to $\rm V_{CC}$ and ground.

Features

- Typical propagation delays —
 Select to outputs (4 delays): 18 ns
 Select to output (5 delays): 28 ns
 Enable to output: 20 ns
- Low power: 40 μW quiescent supply power
- Fanout of 10 LS-TTL devices
- Input current maximum 1 µA, typical 10 pA

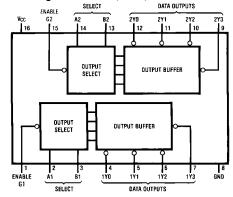
Ordering Code:

Order Number Package Number		Package Number	Package Description				
	MM74HC139M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow				
	MM74HC139SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide				
	MM74HC139MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP) JEDEC MO-153, 4.4mm Wide				
	MM74HC139N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide				

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP



Truth Table

ln	Inputs			Out	puts	
Enable Select						
G	В	Α	Y0	Y1	Y2	Y3
Н	Х	Х	Н	Н	Н	Н
L	L	L	L	Н	Н	Н
L	L	Н	Н	L	Н	Н
L	Н	L	Н	Н	L	Н
L	Н	Н	Н	Н	Н	L

H = HIGH Level L = LOW Level

MM74HC139 Logic Diagram ENABLE G OUTPUTS SELECT (1 of 2)

Absolute Maximum Ratings(Note 1)

(Note 2)

-0.5 to $+7.0$ V
-1.5 to V_{CC} +1.5 V
-0.5 to V_{CC} +0.5V
±20 mA
±25 mA
±50 mA
-65°C to +150°C
600 mW
500 mW
260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T_A)	-40	+85	°C
Input Rise or Fall Times			
$(t_r, t_f) V_{CC} = 2.0V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: – 12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	v _{cc}	T _A =	25°C	T _A = -40 to 85°C	T _A = -55 to 125°C	Units
Зушьог			V CC	Тур		Guaranteed Limits		
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	V
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μА
	Current							
I _{CC}	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND	6.0V		8.0	80	160	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$						

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation		18	30	ns
	Delay, Binary Select to any Output				
	4 levels of delay				
t _{PHL} , t _{PLH}	Maximum Propagation		28	38	ns
	Delay, Binary Select to any Output				
	5 levels of delay				
t _{PHL} , t _{PLH}	Maximum Propagation		19	30	ns
	Delay, Enable to any Output				

AC Electrical Characteristics

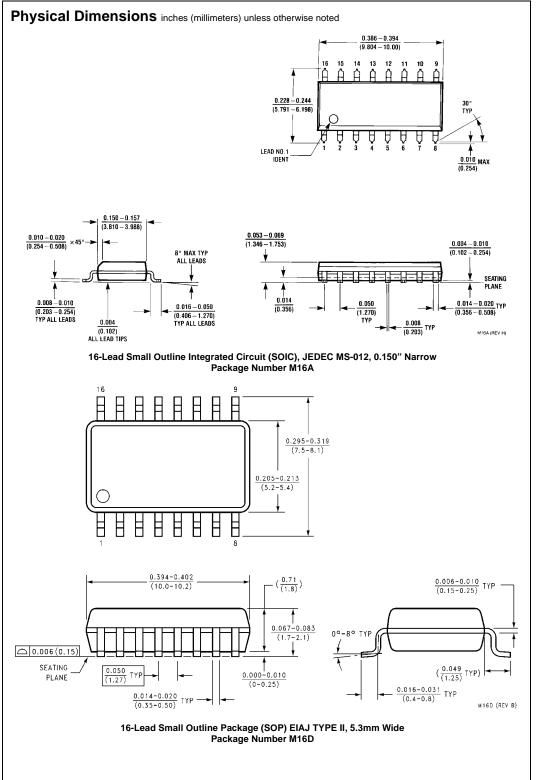
 $C_L = 50$ pF, $t_r = t_f = 6$ ns (unless otherwise specified)

Symbol	Parameter	Conditions	v _{cc}	T _A = 25°C		T _A = -40 to 85°C	T _A = -55 to 125°C	Units	
Cymbol				Тур	Guaranteed Limits			Units	
t _{PHL} , t _{PLH}	Maximum Propagation	(Note 5)	2.0V	110	175	219	254	ns	
	Delay Binary Select to		4.5V	22	35	44	51	ns	
	any Output 4 levels of delay		6.0V	18	30	38	44	ns	
t _{PHL} , t _{PLH}	Maximum Propagation	(Note 6)	2.0V	165	220	275	320	ns	
	Delay Binary Select to any		4.5V	33	44	55	64	ns	
	Output 5 levels of delay		6.0V	28	38	47	54	ns	
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	115	175	219	254	ns	
	Delay Enable to any		4.5V	23	35	44	51	ns	
	Output		6.0V	19	30	38	44	ns	
t _{TLH} , t _{TLH}	Maximum Output Rise		2.0V	30	75	95	110	ns	
	and Fall Time		4.5V	8	15	19	22	ns	
			6.0V	7	13	16	19	ns	
C _{IN}	Maximum Input			3	10	10	10	pF	
	Capacitance								
C _{PD}	Power Dissipation	(Note 7)		75				pF	
	Capacitance (Note 7)								

Note 5: 4 levels of delay are A to Y1, Y3 and B to Y2, Y3.

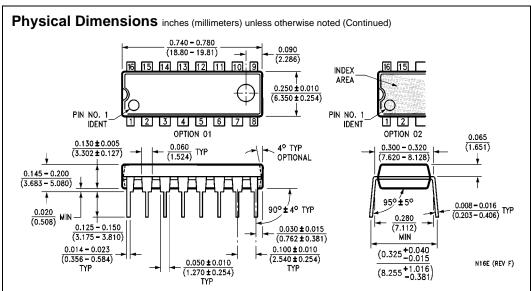
Note 6: 5 levels of delay are A to Y0, Y2 and B to Y0, Y1.

Note 7: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} f + I_{CC}$.



Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 7.72 TYP. DIMENSIONS METRIC ONLY (1.78 TYP) 0.42 TYP LAND PATTERN RECOMMENDATION GAGE PLANE 6.4 0.25 4.4 ± 0.1 -B-3.2 SEATING PLANE 0.6 ± 0.1 DETAIL A △ 0.2 C B A ALL LEAD TIPS TYPICAL, SCALE: 40X SEE DETAIL A PIN #1 IDENT. (0.90) O.1 C--c-0.10 ± 0.05 TYP 0.09-0.20 TYP 0.65 TYP - 0.30 TYP Φ 0.13 M B (S) Α MTC16 (REV C)

16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC16



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N16E

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